

DOCKET NO. END920020007US1

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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Applicant: Choi *et al.*

Examiner: Zimmerman, John J.

Serial No.: 10/078,020

Art Unit: 1775

Filed: 2/15/2002

MAY 04 2004

For: LEAD-FREE TIN-SILVER-COPPER ALLOY SOLDER COMPOSITION

OFFICIAL

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

AMENDMENT

Sir:

In supplementary response to the Final Office Action mailed February 11, 2004, please amend the above-identified application as follows:

OK to Enter
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5/14/04

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